



Material Content Data Sheet



Sales Product Name		TLE4241GM		Issued		20. July 2018		
MA#		MA001259204						
Package		PG-DSO-8-16		Weight*		83.22 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.009	2.41	2.41	24143	24143
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		108	
	non noble metal	zinc	7440-66-6	0.036	0.04		431	
	non noble metal	iron	7439-89-6	0.717	0.86		8618	
wire	non noble metal	copper	7440-50-8	29.121	34.99	35.90	349936	359093
	noble metal	gold	7440-57-5	0.164	0.20	0.20	1969	1969
	encapsulation	organic material	carbon black	1333-86-4	0.097	0.12		1166
plastics	plastics	epoxy resin	-	4.464	5.36		53640	
		silicondioxide	60676-86-0	43.959	52.84	58.32	528232	583038
leadfinish	non noble metal	tin	7440-31-5	0.814	0.98	0.98	9780	9780
plating	noble metal	silver	7440-22-4	0.650	0.78	0.78	7814	7814
glue	plastics	acrylic resin	-	0.259	0.31		3116	
		noble metal	silver	7440-22-4	0.919	1.10	1.41	11047
*deviation	< 10%					Sum in total:	100.00	1000000

Important Remarks:

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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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